

115-43-328-41-001000 Information


For Reference Only

Part Number [115-43-328-41-001000](#)
Manufacturer Mill-Max Manufacturing Corp.
Category Connectors, Interconnects
[Sockets for ICs, Transistors](#)
Description CONN IC DIP SOCKET 28POS GOLD
Package -
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


115-43-328-41-001000 Specifications

Manufacturer Part Number	115-43-328-41-001000
Manufacturer	Mill-Max Manufacturing Corp.
Category	Connectors, Interconnects Sockets for ICs, Transistors
Package	-
Series	115
Type	DIP, 0.3" (7.62mm) Row Spacing
Number of Positions or Pins (Grid)	28 (2 x 14)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	30µin (0.76µm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Open Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Tin
Contact Finish Thickness - Post	200µin (5.08µm)
Contact Material - Post	Brass Alloy
Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester
Operating Temperature	-55°C ~ 125°C

[Report errors?](#)

115-43-328-41-001000 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

115-43-328-41-001000 Payment Methods



115-43-328-41-001000 Shipping Methods



If you have any question about 115-43-328-41-001000, please do not hesitate to contact us!

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